

Global Market for Mixed-signal System-on-Chip Applications with a Focus on Node Geometries

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Abstracts

REPORT INCLUDES:

An overview of the global market for mixed-signal SoC applications and a detailed study on node geometries

Analyses of global market trends, with data from 2018, estimates for 2019, and projections of compound annual growth rates (CAGRs) through 2024

Characterization and quantification of SoC application market by design, technology node, application and region

Comparative study on digital vs manual signals

Detailed information about the major factors influencing the market growth and recent developments within the industry

Company profiles of the leading players in the industry, including Broadcom Corp., Intel Corp., Micron Technology Inc., Qualcomm Inc., Taiwan Semiconductor, and Toshiba Corp.

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